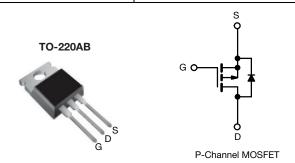


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	-200				
$R_{DS(on)}$ max. (Ω)	V _{GS} = -10 V 0.80				
Q _g max. (nC)	29				
Q _{gs} (nC)	5.4				
Q _{gd} (nC)	15				
Configuration	Single				



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- · Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF9630PbF		
	SiHF9630-E3		
SnPb	IRF9630		
סוורט	SiHF9630		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	-200		
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Drain Current	V at 10 V	T _C = 25 °C	I _D	-6.5		
Continuous Drain Current	V _{GS} at -10 V	T _C = 100 °C		-4.0	Α	
Pulsed Drain Current a			I _{DM}	-26		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	500	mJ	
Repetitive Avalanche Current ^a			I _{AR}	-6.4	Α	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P_{D}	74	W	
Peak Diode Recovery dV/dt ^c			dV/dt	-5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	00	
Soldering Recommendations (Peak temperature) d for 10 s			_	300	°C	
Mounting Toyour	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = -50$ V, starting $T_J = 25$ °C, L = 17 mH, $R_g = 25$ Ω , $I_{AS} = -6.5$ A (see fig. 12). c. $I_{SD} \le -6.5$ A, dl/dt ≤ 120 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C. d. 1.6 mm from case.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					Į.		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA		-200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = -1 mA	-	-0.24	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	' _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I _{GSS}	Vo	V _{GS} = ± 20 V		-	± 100	nA
Zan Oala Valla a Buria Oamal		$V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	-100	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -160 \text{ V},$	V _{GS} = 0 V, T _J = 125 °C	-	-	-500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -3.9 A ^b	-	-	0.80	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = -5$	60 V, I _D = -3.9 A ^b	2.8	-	-	S
Dynamic						•	
Input Capacitance	C _{iss}	,	$I_{GS} = 0 \text{ V},$	-	700	-	pF
Output Capacitance	C _{oss}	V	os = -25 V,	-	200	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5	-	40	-	
Total Gate Charge	Qg		I _D = -6.5 A,	-	-	29	
Gate-Source Charge	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -160 \text{ V},$	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 b	-	-	15	
Turn-On Delay Time	t _{d(on)}			-	12	-	
Rise Time	t _r	V_{DD} = -100 V, I_D = -6.5 A, R_g = 12 Ω , R_D = 15 Ω , see fig. 10 b		-	27	-	ns
Turn-Off Delay Time	t _{d(off)}			-	28	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	-11
Internal Source Inductance	L _S	package and ce die contact	package and center of die contact		7.5	-	- nH
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.6	-	3.7	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbo	MOSFET symbol showing the			-6.5	^
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p -n junction diode		-	-	-26	A
Body Diode Voltage	V _{SD}	$T_J = 25$ °C, $I_S = -6.5$ A, $V_{GS} = 0$ V b		-	-	-6.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = -6.5$ A, $dI/dt = 100$ A/ μ s b		-	200	300	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.9	2.9	μC
Forward Turn-On Time	t _{on}	Intrinsic turr	n-on time is negligible (turn	on is do	minated b	v Le and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

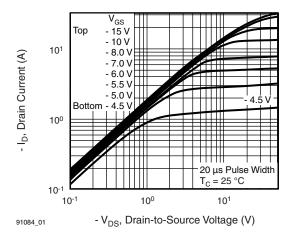


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

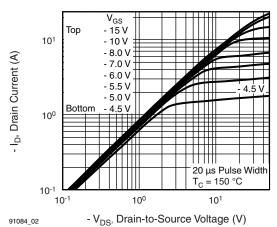


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

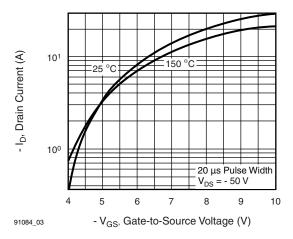


Fig. 3 - Typical Transfer Characteristics

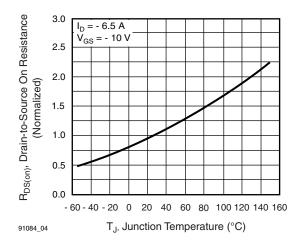


Fig. 4 - Normalized On-Resistance vs. Temperature

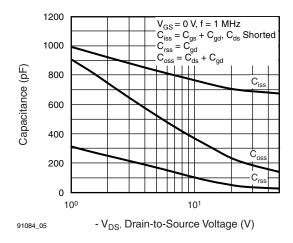


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

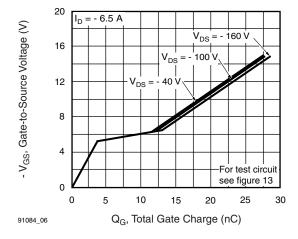


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



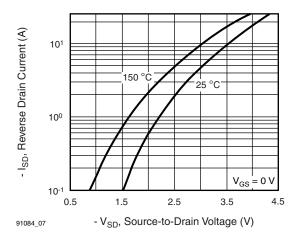


Fig. 7 - Typical Source-Drain Diode Forward Voltage

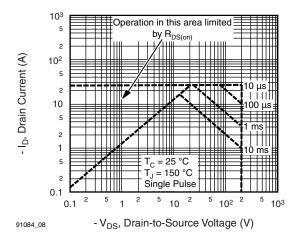


Fig. 8 - Maximum Safe Operating Area

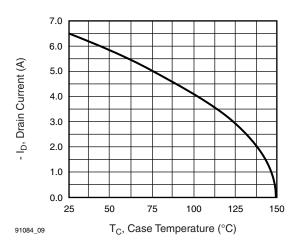


Fig. 9 - Maximum Drain Current vs. Case Temperature

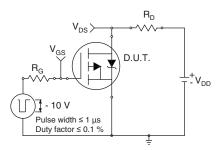


Fig. 10a - Switching Time Test Circuit

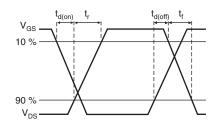


Fig. 10b - Switching Time Waveforms

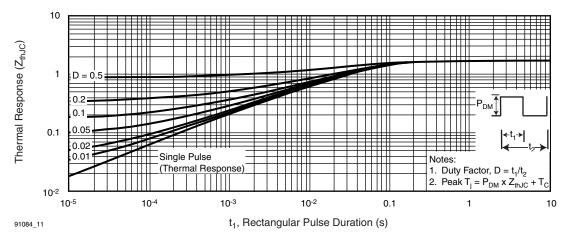


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



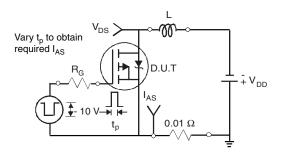


Fig. 12a - Unclamped Inductive Test Circuit

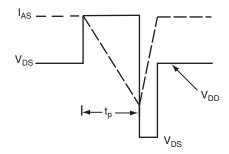


Fig. 12b - Unclamped Inductive Waveforms

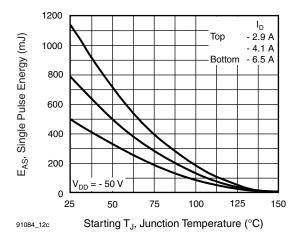


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

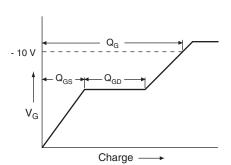


Fig. 13a - Basic Gate Charge Waveform

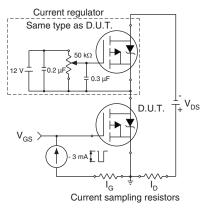
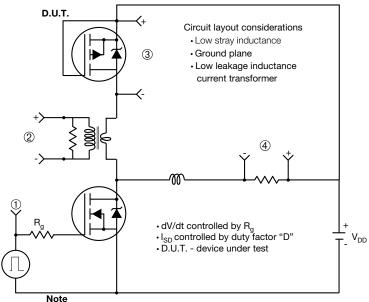


Fig. 13c - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

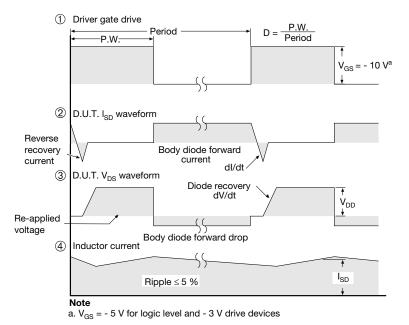


Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91084.





TO-220-1



DIM	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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